



Description

The 828 Series fuses are specifically designed and test to the circuit protection needs of compact auto-electronics applications. This series is rated 1,000Vdc with remarkable interrupting rating.

Features and Benefits

- Available in Through Hole and Bolt Down version
- RoHS-compliant, lead-free and halogen-free.
- Recognized to UL/CSA/NMX 248-1 and UL/CSA/NMX 248-14 for the US and Canadian Markets
- Small size
- High voltage
- High breaking capacity

Additional Information



Resources





Accessories

Samples

Applications

- On-Board Charger
- Power Distribution Unit

Agency Approvals

Agency	Agency File Number	Ampere Range
c FL °us	E10480	15 A ~ 30 A

Electrical Characteristics

% of Ampere Rating	Ampere Rating	Opening Time at 25°C
100%	15 A ~ 30 A	4hrs, Min.
135%	15 A ~ 30 A	3600 seconds, Max.

Electrical Specifications

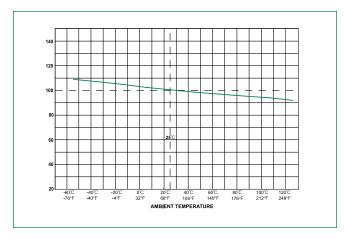
Ampere Rating	Rating Amp	Max Voltage Rating	Interrupting Rating	Nominal Cold Resistance	Nominal Melting	Agency Approvals
(A) Code	(V)	(AC/DC)	(mOhm)	I ² t (A ² sec)	c SU °us	
15	015.	1000Vdc	10KA@1000Vdc	7.65	190	Х
20	020.			4.90	536	X
25	025.			3.20	1190	X
30	030.			2.90	1500	X

Note: Unless otherwise stated, all specifications are referenced at room ambient temperature.



828 Series High Voltage Cartridge Fuses

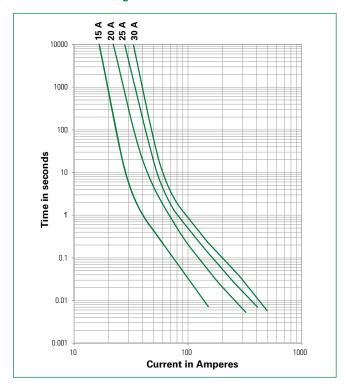
Temperature Re-rating Curve



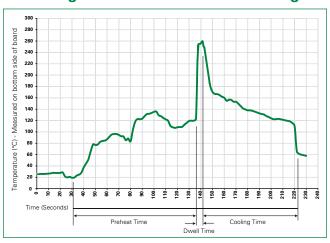
Product Characteristics

Materials	Body: Glass fiber Cap: Tin plated Copper alloy	
Mechanical Shock	MIL-STD-202, Method 213, Test Condition I (100 G's peak for 6 milliseconds)	
Solderability	Reference MIL-STD-202 method 208	
Product Marking	Brand logo, current and voltage ratings	
Resistance to Solder Heat	MIL-Std 202 Method 210 Test Condition B (10sec at 260 °C)	
Operating Temperature	-55 °C to +125 °C	
Vibration	MIL-STD-202G, Method 201A	
Salt Spray	MIL-STD-202G, Method 101E, Test condition B	

Average Time Current Curves



Soldering Parameters-Wave Soldering



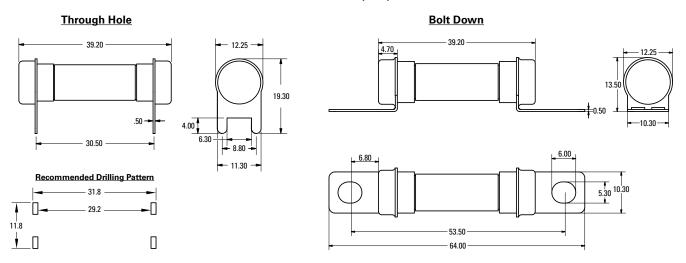
Wave Parameter	Lead-Free Recommendation
Preheat: (Depends on Flex Activation Temperature)	(Typical Industry Recommendation)
Temperature Minimum	100 °C
Temperature Maximum	150 °C
Preheat Time	60-180 seconds
Solder Pot Temperature	260 °C Maximum
Solder Dwell Time	2-5 seconds

Recommended Hand-Solder Parameters:

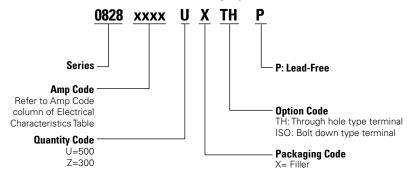
Solder Iron Temperature: $350\,^{\circ}\text{C}$ +/- $5\,^{\circ}\text{C}$ Heating Time: 5 seconds max. **Note:** These devices are not recommended for IR or Convection Reflow process.



Dimensions (mm)



Part Numbering System



Packaging

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code	Reel Size
828 Though Hole Version				
Tray	NA	500	UXTH	NA
828 Bolt Down Version				
Tray	NA	300	ZXISO	NA

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